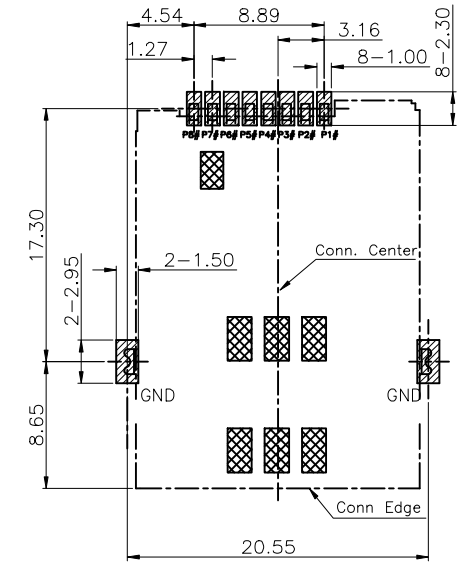
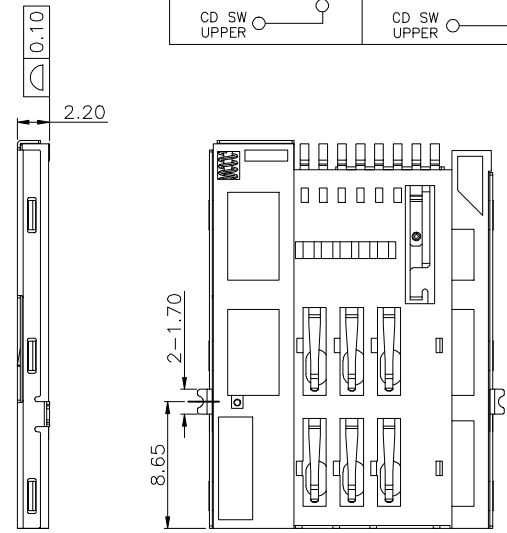
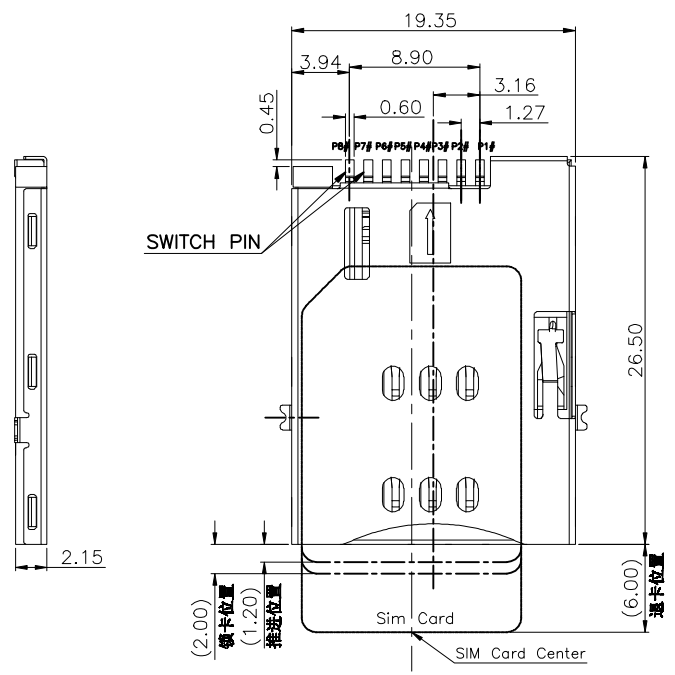
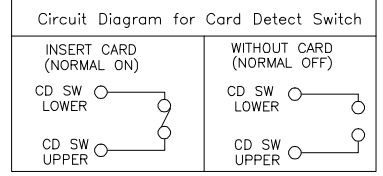


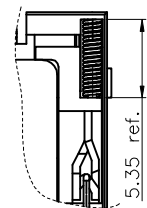
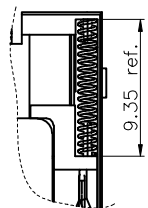
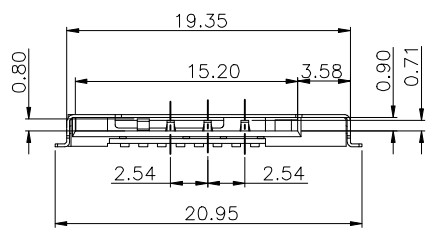
Customer drawings  
Reference only

REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2016/08/08



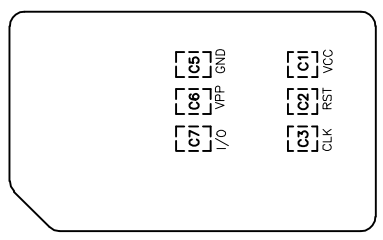
RECOMMENDED PCB LAYOUT(TOP VIEW)  
GENERAL TOLERANCES:±0.05

SOLDER AREA  
 NONE CIRCUIT DIAGRAM AREA



NOTES:  
1)MATERIAL:  
HOUSING: LCP UL 94V-0  
CONTACT: C5210R-H,T=0.15  
SHELL: SUS201,T=0.15  
MYLAR: POLYESTER  
2)FINISH :  
CONTACT:GOLD FLASH PLATED ON CONTACT AREA;  
GOLD FLASH PLATING ON SOLDER TAILS, WITH  
ENTIRE CONTACT UNDERPLATED 50u"Min. NICKEL  
SHELL: 50u"Min. NICKEL UNDERPLATED OVERALL ,  
GOLD FLASH PLATED ON SOLDER TAILS  
3.INFRARED REFLOW SOLDERING: 10sec. Min. at 260±10

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	POL
P8#	DET



SIM 示意图  
芯片面朝下视图

GENERAL TOLERANCE		DWG NO.	LAZ0820-008	APPD:	WIND	Scale	1:1
X.±0.45	x.'±5'	Title	PUSH SIM CARD 6+2PIN 2.20H	CHKD:		UNIT	mm
.X±0.35	.x'±2'			DR:			
.XX±0.25	.xx'±1'	Part NO.	ASMFS220A01BR115	Date	2016/09/02		
.XXX±0.15	.xxx'±0.5'	东莞市捷圣泰电子科技有限公司 Dongguan JASSTA Electronics Co.,LTD					
SHEET	1/1						